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PATENT APPLICATION
IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of

Docket No: Q63636

Walter EEVERS, et al.

Appln. No.: 09/818,936

Group Art Unit: 1771

Confirmation No.: 9629

Examiner: Elizabeth M. COLE

Filed: March 28, 2001

For: WATER-PERMEABLE ADHESIVE TAPE.

DECLARATION UNDER 37 C.F.R. § 1.132

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

I, Dr. Anno ISSARIS, hereby declare and state:

THAT I am a citizen of Belgium;

THAT I have received a PhD in Sciences from LIMBURGS UNIVERSITEIT on
NOVEMBER 1997; CENTRUM (B)THAT I have been employed by Nitto Europe N.V. since 1997,
where I hold a position as Scientist, with responsibility for
the development of new base technologies related to "coating"; andTHAT I am a co-Inventor of the above-identified application and am familiar with the
prosecution of the application, including the non-final Office Action mailed May 9, 2006.I declare that I am one of ordinary skill in the art of adhesive tapes, and the present
specification, as originally filed on March 28, 2001, clearly conveys to me the invention of
present Claim 1, including an adhesive tape comprising (i) at least one water-permeable base
film which possesses perforations and has a cavity ratio of 3.0 to 90% and (ii) an adhesive not

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RULE 132 DECLARATION
U.S. Appl. No. 09/818,936

having perforations applied on one surface of the base film, wherein the adhesive is coextensive with the at least one base film.

In this regard, the purpose of our adhesive tape is to hold chips and IC parts. If the adhesive (ii) and perforated layer (i) are not coextensive, it is expected that the IC parts cannot be held due to delamination between the adhesive and the perforated layer. Indeed, an adhesive tape used in the field of processing chips and IC parts is formed conventionally with a coextensive adhesive and substrate. In the invention of Claim 1, the substrate possesses perforations and has a cavity ratio of 3.0 to 90% and the adhesive does not have perforations. However, the fact that the adhesive and perforated layer are coextensive, as recited in Claim 1, is not new matter.

I declare further that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code, and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

Date: 15/09/2006
Dr. Anne ISSARIS